Suppression of exciton quenching in all-inorganic quantum dot light-emitting diode through surface treatment

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Inorganic hole transport materials in quantum dot light-emitting diodes (QD-LEDs) have emerged because of its inherently high stability in harsh driving conditions and oxygen and water-resistant properties. NO is one of the suitable candidate for inorganic hole transport materials (HTM) owing to its stability and moderate mobility. However, NO-based all-inorganic QD-LEDs exhibit poor performance than organic-HTL based QD-LEDs low performance of NO-based all-inorganic QD-LEDs is due to exciton quenching caused by free carriers and surface traps on the surface of NO hole transport layers (HTLs). We try to suppress exciton quenching by passivating the trap site of NO using an appropriate ligand. The ligand exchange method was applied to NO, XPS will be conducted for analysis of NO surface, and the suppression of exciton quenching will be evaluated through PL decay of QD/NO.